STK621-061-E

ON Semiconductor®

Thick-Film Hybrid IC

3-Phase Motor Drive Inverter Hybrid IC

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Overview

This IC is a 3-phase inverter power hybrid IC containing power elements (IGBT and FRD), pre-driver, overcurrent and excessive temperature protection circuit.

Application

• 3-phase inverter motor drive

Features

- Integrates power elements (IGBT and FRD), pre-driver, and protective circuit.
- Protective circuits including overcurrent (bus line), excessive temperature and pre-drive low voltage protection are built in.
- Direct input of CMOS level control signals without an insulating circuit (photocoupler, etc) is possible.
- Single power supply drive is possible by using a bootstrap circuit with a built-in IC
- Temperature monitor is possible by the thermistor inside the IC
- Built-in simultaneous upper/lower ON prevention circuit to prevent arm shorting through simultaneous ON input for the upper and lower side transistors.
 - (Dead time is required for preventing shorting due to switching delay.)
- SIP (The single in-line package) of the transfer full mold structure.

Specifications

Absolute Maximum Ratings at Tc = 25°C

Parameter	Symbol	Conditions		Ratings	unit
Supply voltage	V _{CC}	+, surge < 500V	*1	450	V
Collector-emitter voltage	V _{CE}	+ - U (V, W) or U (V, W)		600	V
Output current	IO	+, -, U, V, W terminal current		±30	Α
Output peak current	lop	+, -, U, V, W terminal current PW = 100μs		±45	Α
Pre-driver supply voltage	VD1, 2, 3, 4	VB1 - U, VB2 - V, VB3 - W, V _{DD} - V _{SS} *2		20	V
Input signal voltage	V _{IN}	HIN1, 2, 3, LIN1, 2, 3 terminal		0 to 7	V
FAULT terminal voltage VFAULT		FAULT terminal		20	V
Maximum loss	Pd	Per 1 channel		49	W
Junction temperature	Tj	IGBT, FRD junction temperature		150	°C
Storage temperature	Tstg			-40 to +125	°C
Operating temperature TC		H-IC case temperature		-20 to +100	°C
Tightening torque		A screw part at use M4 type screw *3		1.17	N•m
Withstand voltage	Vis	50Hz sine wave AC 1 minute	*4	2000	VRMS

In the case without the instruction, the voltage standard is - terminal = VSS terminal voltage.

- *1 Surge voltage developed by the switching operation due to the wiring inductance between the + and –terminals.
- *2 VD1 = between VB1-U, VD2 = VB2-V, VD3 = VB3-W, VB4 = V_{DD}-V_{SS}, terminal voltage.
- *3 Flatness of the heat-sink should be lower than 0.25mm.
- *4 The test condition is AC 2500V, 1 second.

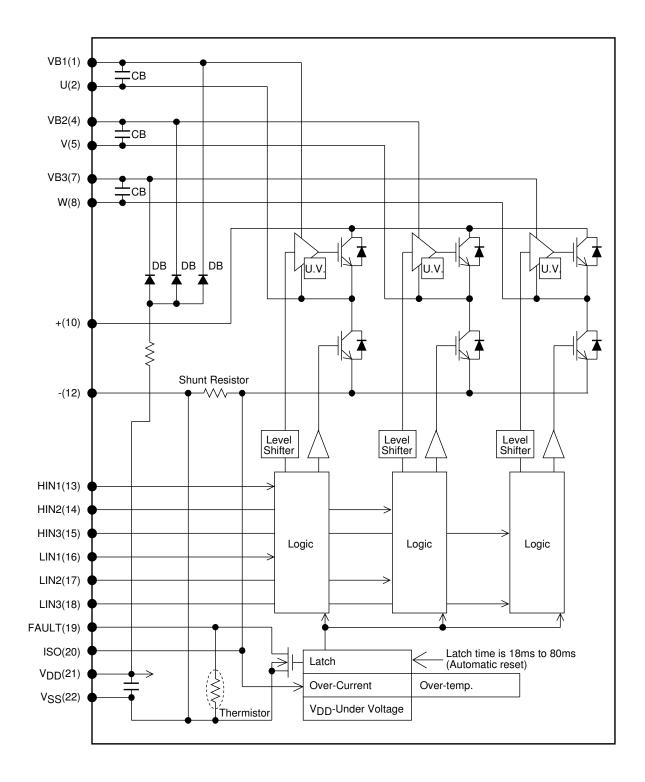
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Electrical Characteristics at Tc=25°C, VD=15V

Davisantan	Symbol	0-	Conditions		Ratings			unit
Parameter	Symbol	Co	nations	Circuit	min	typ	max	unit
Power output part								
Collector-to-emitter cut-off current	ICE	V _{CE} = 600V		Fig.1			0.5	mA
Boot-strap diode reverse current	IR (BD)	VR (BD) = 60	VOOV	Fig.1			0.5	mA
Collector-to-emitter saturation voltage	V _{CE} (SAT)	I _O = 15A	Upper side	Ε: 0		1.8		V
			Lower side	Fig.2		2.0		٧
Diode forward voltage	VF	I _O = -15A	Upper side	F: 0		1.7		V
			Lower side	Fig.3		1.9		V
Junction-to-substrate thermal resistance	θј-с (Т)	IGBT				2.1		°C/W
	θj-c (D)	FWD				2.5		°C/W
Control (Pre-driver) part	•							
Pre-drive power supply consumption	ID	VD1, 2, 3 = 15V VD4 = 15V				0.07	0.4	_
electric current				Fig.4		2	5	mA
Input ON voltage	V _{IH}	Output ON					0.8	V
Input OFF voltage	V _{IL}	Output OFF			3.0			V
Protection part	•							
Excessive temperature	TSD	The substrate	e surface		100		120	°C
Overcurrent protection electric current	ISD	PW = 100μs		Fig.5	46		58	Α
Pre-drive low voltage protection	UVLO				10		12	V
Fault terminal input electric current	IOSD	VFault = 0.1\	/			0.5		mA
Fault clearness delay time	FLTCLR	After each properation end			18		80	ms
Board Temperature Mounting resistance	Rt	Resistance between the Fault and VSS terminals			90		110	kΩ
						•		
Switching time	tON	I _O = 15A, Inc	luctive load	Fi. 0		0.8		μs
	tOFF			Fig.6		1.0		μs
Electric current output signal level	ISO	I _O = 15A	I _O = 15A			0.141		V

In the case without the instruction, the voltage standard is - terminal = V_{SS} terminal voltage.

Internal Equivalent Circuit Diagram



Test Circuit

Fig 1: I_{CE}

	U+	V+	W+	U-	V-	W-
М	10	10	10	2	5	8
N	2	5	8	12	12	12

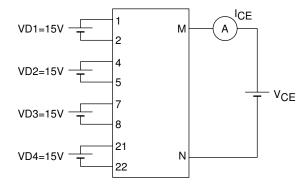


Fig 2: V_{CE}(SAT)

	U+	V+	W+	U-	V-	W-
М	10	10	10	2	5	8
N	2	5	8	12	12	12
m	13	14	15	16	17	18

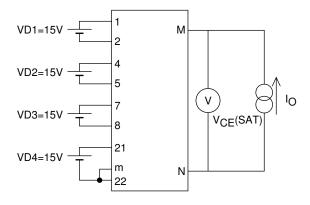


Fig 3: V_F

	U+	V+	W+	U-	V-	W-
М	10	10	10	2	5	8
N	2	5	8	12	12	12

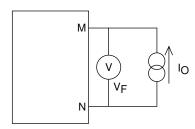


Fig 4: ID

	VD1	VD2	VD3	VD4
m	1	4	7	21
n	2	5	8	22

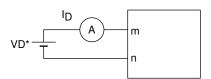
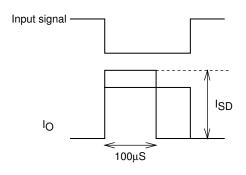


Fig 5: ISD



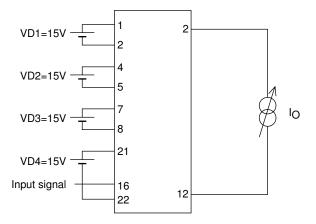
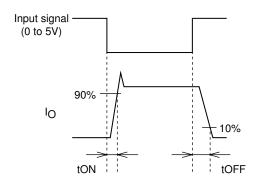
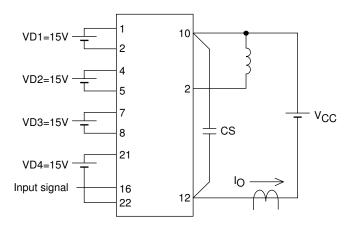
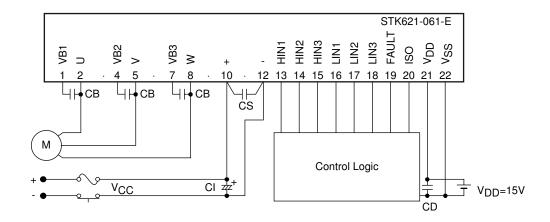


Fig 6: Switching Time





Example of the application circuit



STK621-061-E

Recommendation Operating Conditions

Parameter	Symbol	Symbol Conditions		typ	max	unit
Supply voltage	V _{CC}	+	0	280	400	V
Pre-driver supply voltage	VD1, 2, 3	VB1 - U, VB2 - V, VB3 - W	12.5	15	17.5	.,
	VD4	V _{DD} - V _{SS} *1	13.5	15	16.5	V
Input ON voltage	V _{IN} (ON)	HIN1, HIN2, HIN3,	0		0.3	.,,
Input OFF voltage	V _{IN} (OFF)	LIN1, LIN2, LIN3 Terminal	3.5		5	V
PWM frequency	fPWM		1		20	kHz
Dead time	DT	Upper/lower input signal downtime	2			μs
Tightening torque	MT	'M4' Type Screw	0.79		1.17	N•m

^{*1.} Pre-driver power supply (VD4 = 15 ± 1.5 V) must have the capacity of $I_O = 20$ mA (DC), 0.5A (Peak).

Usage Precaution

- Single power supply drive is possible by using a bootstrap circuit with a built-in IC.
 (When not using bootstrap circuit, each upper side pre-drive power supply needs an independent power supply.
 Externally set.)
 - Also, the upper side power supply voltage sometimes declines by the way of controlling. Confirm it.
- 2. Because the jump voltage which is accompanied by the vibration in case of switching operation occurs by the influence of the floating inductance of the wiring of the outer power supply which is connected with of the + terminal and the –terminal, restrains and spares serge voltage being as the connection of the snubber circuit (Capacitor/CS/about $0.1 10\mu F$) for the voltage absorption with the neighborhood as possible between + and the terminal, and so on, with making a wiring length (among the terminals each from CI) short and making a wiring inductance small.
- 3. ISO terminal (20pin) is for the electric current monitor. Be careful, because the overcurrent protection does not operate when short-circuiting in the ISO terminal and the VSS terminal.
- 4. Output form of the FAULT terminal is open DRAIN (it is operating as FAULT when becoming LOW). When the pull up with the resistance, use above $5.6k\Omega$.
- 5. Zener diode with 5V (5.0 5.4V) is connected with the inside of the signal input terminal. When inputting the voltage which exceeds 5V, connect resistor to between the side of the power and the signal input terminal, for the input current of the signal input terminal become equal to or less than 0.5mA.

 This resistor is effective with the noise absorption of the signal terminal, too.
- 6. The overcurrent protection feature operates only when it is possible to do a circuit control normally. For the safety, put a fuse, and so on in the V_{CC} line.
- 7. Because the IC sometimes destroys and bursts when motor connection terminal (2pin, 5pin, 8pin) becomes open while the motor turns, especially, be careful of the connection (the soldering condition) of this terminal.
- If terminal and VSS terminal are short-circuited, since an over-current protection (ISD) value will become lower than the inside setting value of HIC, please do not connect externally.
 (-terminal and VSS terminal are connected inside HIC)

This data shows the example of the application circuit, does not guarantee a design as the mass production set.

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